

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

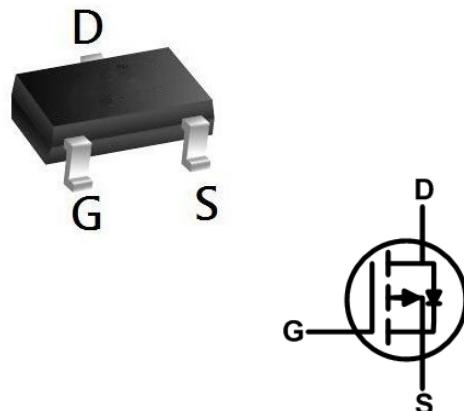
**Product Summary**

BVDSS	RDS(on)	ID
-30V	20mΩ	-9.0A

**Description**

The JHG7P03AL is the high cell density trenched P-ch MOSFETs, which provide excellent RDS(on) and gate charge for most of the synchronous buck converter applications.

The JHG7P03AL meet the RoHS and Green Product requirement

**SOT23-3L Pin Configuration****Absolute Maximum Ratings** ( $T_A=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		-30	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current	$T_A = 25^\circ\text{C}$	-9	A
		$T_A = 100^\circ\text{C}$	-5.0	A
$I_{DM}$	Pulsed Drain Current <sup>note1</sup>		-36	A
$E_{AS}$	Single Pulsed Avalanche Energy <sup>note2</sup>		25	mJ
$P_D$	Power Dissipation	$T_A = 25^\circ\text{C}$	3.0	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		48	$^\circ\text{C}/\text{W}$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$

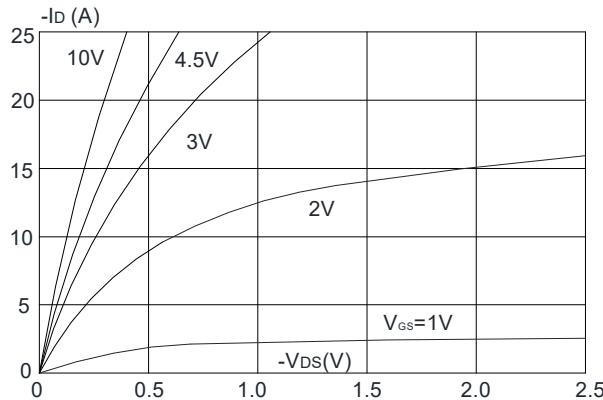
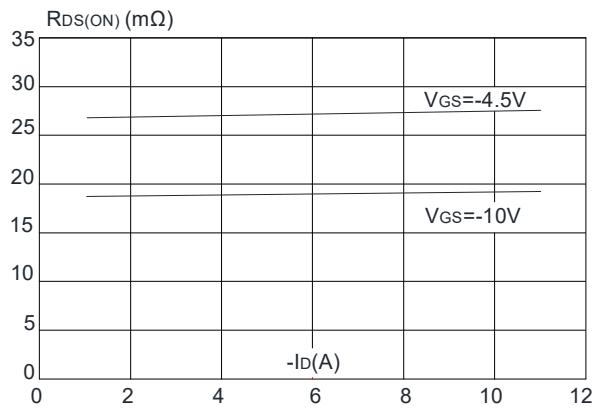
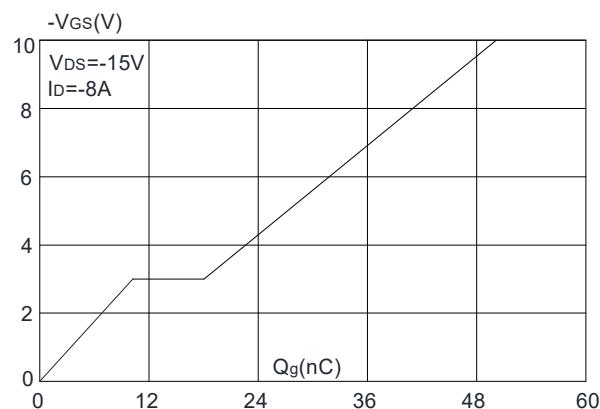
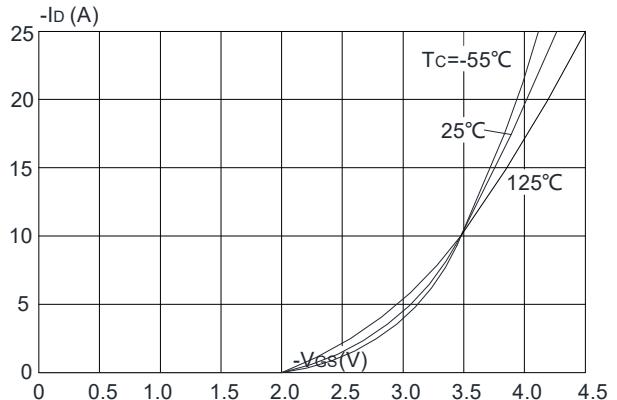
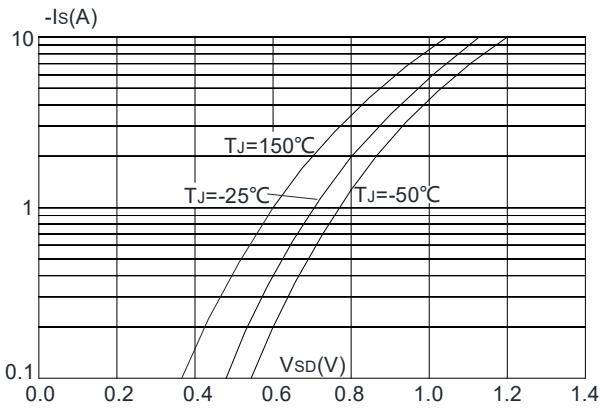
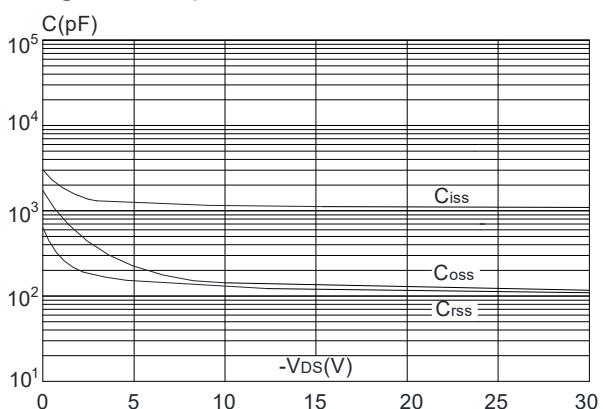
## P-Ch 30V Fast Switching MOSFETs

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise specified)

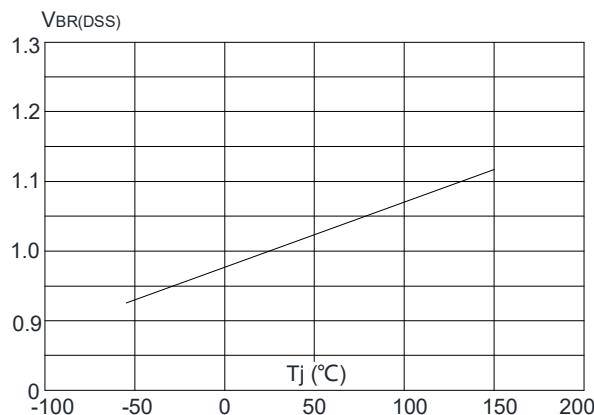
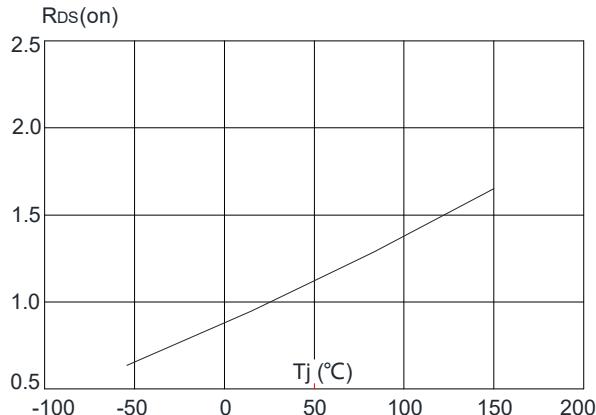
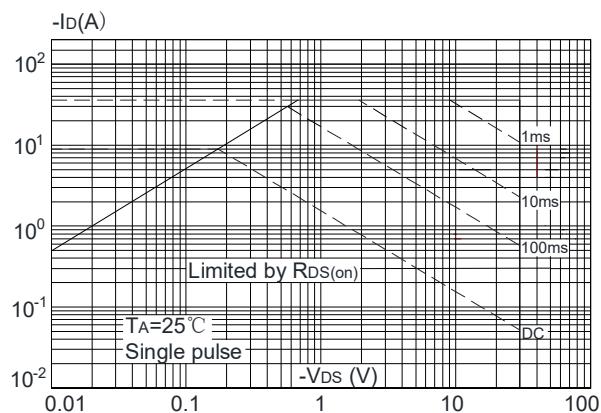
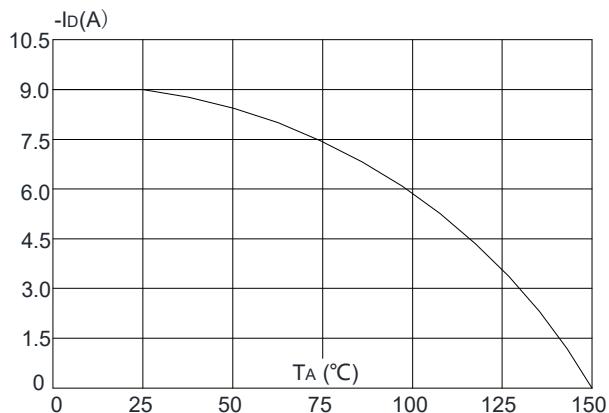
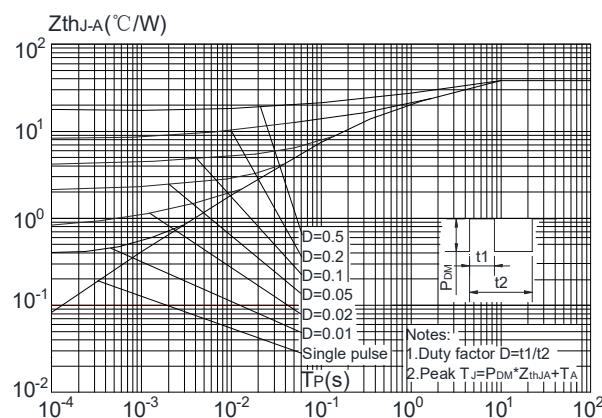
Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristic</b>						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D = -250\mu\text{A}$	-30	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V,$	-	-	-1	$\mu\text{A}$
$I_{GSS}$	Gate to Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.0	-1.5	-2.5	V
$R_{DS(\text{on})}$ Note3	Static Drain-Source on-Resistance	$V_{GS} = -10V, I_D = -9A$	-	20	25	$\text{m}\Omega$
		$V_{GS} = -4.5V, I_D = -5A$	-	27	38	
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$	-	900	-	pF
$C_{oss}$	Output Capacitance		-	125	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	109	-	pF
$Q_g$	Total Gate Charge	$V_{DS} = -15V, I_D = -8A,$ $V_{GS} = -10V$	-	42	-	nC
$Q_{gs}$	Gate-Source Charge		-	8.8	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	7.3	-	nC
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = -15V, I_D = -1A,$ $V_{GS} = -10V, R_{GEN} = 6\Omega$	-	13	-	ns
$t_r$	Turn-on Rise Time		-	15	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	198	-	ns
$t_f$	Turn-off Fall Time		-	98	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	-9	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	-36	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_S = -9A$	-	-0.8	-1.2	V

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition:  $T_J=25^\circ\text{C}$ ,  $V_{DD}=-15V$ ,  $V_G=-10V$ ,  $R_G=25\Omega$ ,  $L=0.5\text{mH}$ ,  $I_{AS}=-10A$ 3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$ , Duty Cycle $\leq 2\%$

**Typical Performance Characteristics****Figure 1:** Output Characteristics**Figure 3:** On-resistance vs. Drain Current**Figure 5:** Gate Charge Characteristics**Figure 2:** Typical Transfer Characteristics**Figure 4:** Body Diode Characteristics**Figure 6:** Capacitance Characteristics

## P-Ch 30V Fast Switching MOSFETs

**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature**Figure 8:** Normalized on Resistance vs. Junction Temperature**Figure 9:** Maximum Safe Operating Area**Figure 10:** Maximum Continuous Drain Current vs. Ambient Temperature**Figure 11:** Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

## P-Ch 30V Fast Switching MOSFETs

## Test Circuit

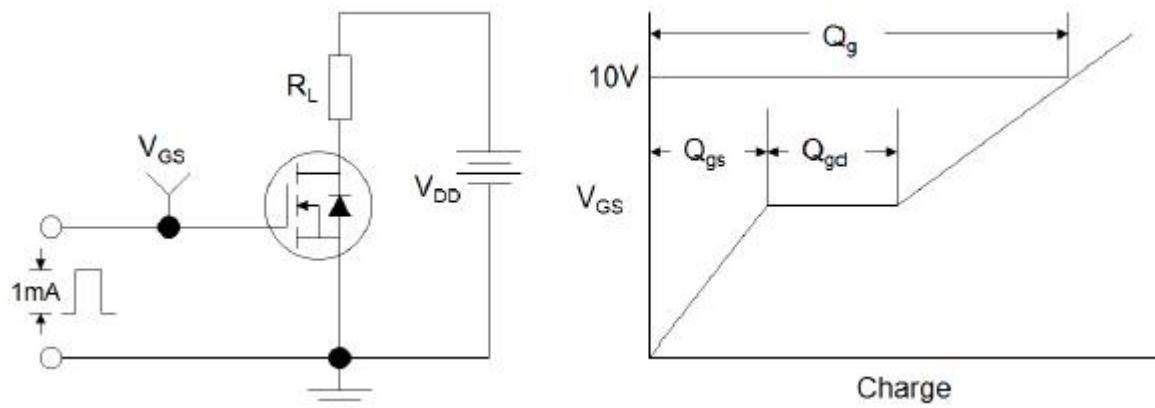


Figure 1: Gate Charge Test Circuit &amp; Waveform

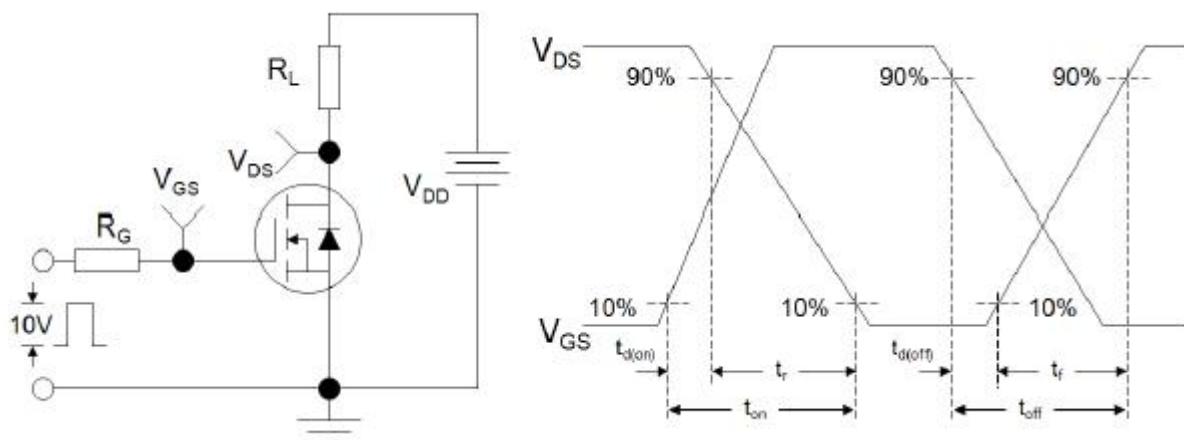


Figure 2: Resistive Switching Test Circuit &amp; Waveforms

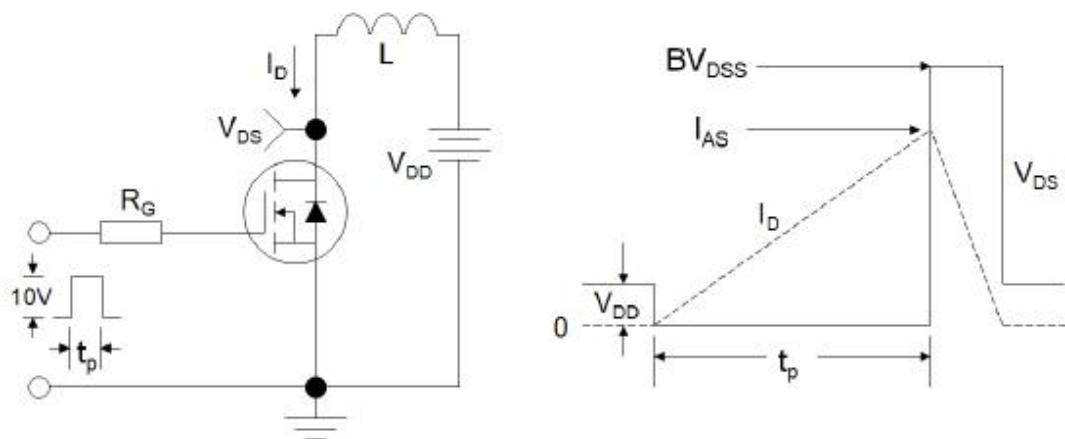
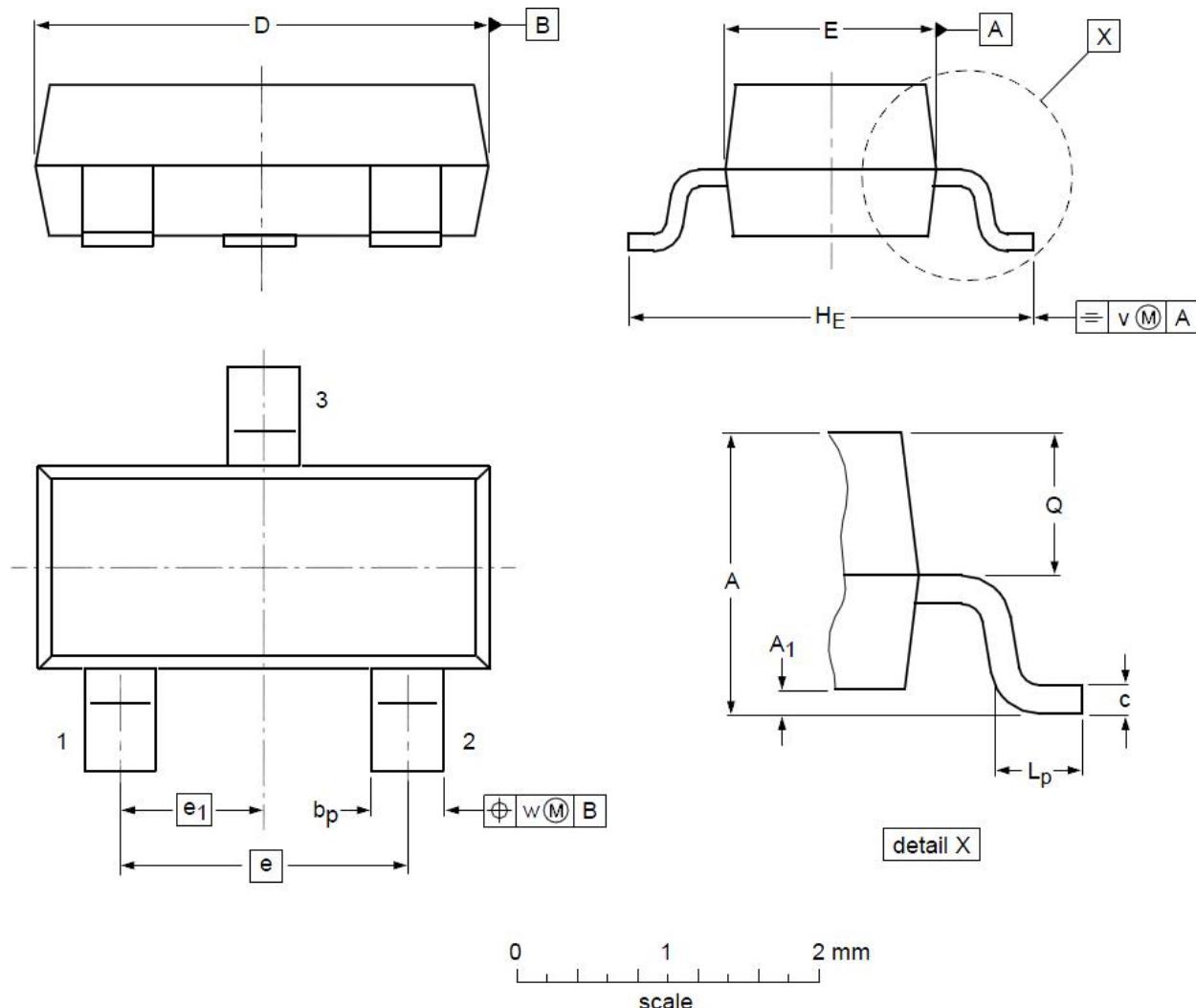


Figure 3: Unclamped Inductive Switching Test Circuit &amp; Waveforms

## P-Ch 30V Fast Switching MOSFETs

## Package Mechanical Data-SOT-23-3L



## DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
<b>A</b>	0.90	1.01	1.15	<b>A<sub>1</sub></b>	0.01	0.05	0.10
<b>b<sub>p</sub></b>	0.30	0.42	0.50	<b>c</b>	0.08	0.13	0.15
<b>D</b>	2.80	2.92	3.00	<b>E</b>	1.20	1.33	1.40
<b>e</b>	--	1.90	--	<b>e<sub>1</sub></b>	--	0.95	--
<b>H<sub>E</sub></b>	2.25	2.40	2.55	<b>L<sub>p</sub></b>	0.30	0.42	0.50
<b>Q</b>	0.45	0.49	0.55	<b>v</b>	--	0.20	--
<b>w</b>	--	0.10	--				